Dotted box > PCB manufacturer info

Layer Name	Туре	Material	Thickness (mm)	Color	Epsilon R	Loss Tangent
F.Silkscreen	Top Silk Screen	Not specified	0 mm	Not specified	1	0
F.Paste	Top Solder Paste		0 mm		1	0
F.Mask	Top Solder Mask	Not specified	0.01 mm	Not specified	3.3	0
F.Cu	copper		0.035 mm		1	0
Dielectric	core	FR4	1.51 mm	Not specified	4.5	0.02
B.Cu	copper		0.035 mm		1	0
B.Mask	Bottom Solder Mask	Not specified	0.01 mm	Not specified	3.3	0
B.Paste	Bottom Solder Paste		0 mm		1	0
B.Silkscreen	Bottom Silk Screen	Not specified	0 mm	Not specified	1	0

BOARD CHARACTERISTICS

Edge card connectors: Outer Copper Weight:

Via type:

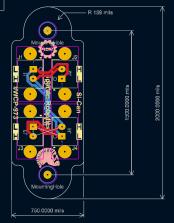
 Copper Layer Count:
 2
 Board Thickness:
 1.6000 mm

 Board overall dimensions:
 19.0500 mm x 50.7951 mm

 Min track/spacing:
 0.0000 mm / 0.2540 mm
 Min hole diameter:
 0.3000 mm

 Copper Finish:
 HASL
 Impedance Control:
 No

 Castellated pads:
 No
 Plated Board Edge:
 No





Sheet:					
File: TEE-CAN.kicad_pcb					
Title:					\sqcap
Size: A4	Date:			Rev:	